

## SETTLEMENT ANNOUNCEMENT

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The Company refers to its announcements dated 22 September 2008 and 16 February 2009.

The Board is pleased to announce that its wholly owned subsidiary, Semiconductor Technologies & Instruments Pte Ltd (“STI”) has recently reached an out-of-court settlement on mutually acceptable terms with Ismeca Semiconductor Holding S.A., Ismeca Malaysia Sdn Bhd and Ismeca Europe Semiconductor S.A. (jointly referred to as “Ismeca”) as regards the following suits:

- a. Civil Suit No. 794 of 20081A in the High Court of the Republic of Singapore (“Singapore Suit”); and
- b. Civil Suit No. (IP) D5-22-17-09 and Civil Suit No. (IP) D5-22-18-09 in the Kuala Lumpur High Court of Malaysia (“Malaysian Suits”)

that relate to alleged infringement of patents by STI.

Save as to the disclosure of the existence of the Settlement Agreement, both parties as part of the terms of settlement, have agreed to keep all the terms of the settlement strictly confidential.

As a result of the confidential settlement, the Singapore Suit and the Malaysian Suits have been wholly discontinued by Ismeca and STI shall be free to sell its scan pack machines with its existing design worldwide.

By Order of the Board

Woo Kwek Kiong  
Company Secretary  
23 July 2010